



PATENT
UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANTS: TAI ET AL - 3 PCT

SERIAL NO.: 10/551,067 EXAMINER: LAM, CATHY GONG FONG

FILED: SEPTEMBER 29, 2005 GROUP: 1775

TITLE: ELECTRICAL CONNECTION COMPONENT

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

MAIL STOP AMENDMENT

Commissioner of Patents

P.O. Box 1450

Alexandria, VA 22313-1450

| 05/03/2007 HDESTA1 00000027 10551067

| 01 FC:1806

180.00 DP

Dear Sir:

Supplemental to the Information Disclosure Statement filed on September 29, 2005, Applicants are enclosing Form PTO-1449 and a copy of JP 7-336026 and JP 2004-039543 which were cited in the International Search Report and listed in Applicant's September 29, 2005 Information Disclosure Statement, which the Examiner indicated she had not considered.

Although the Examiner indicated that copies of these references had not been received, Applicants believe that these references should have been transmitted by the International Office. In any event, Applicants resubmit them herewith.

The enclosed Form PTO-1449 also lists the remaining references listed in Applicants' September 29, 2005 Information Disclosure Statement, namely WO 0554324, JP 3-110408, (Patent Number JP 2000-193944 = U.S. Patent No. 6,398,560) and JP 2000-223835, copies of

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which were submitted with the September 29, 2005 Information Disclosure Statement. U.S. Patent No. 6,398,560 is believed to be the English-language equivalent of JP 3-110408. A copy of the U.S. Patent is not enclosed pursuant to current Patent and Trademark Office guidelines. Applicants respectfully submit that these references should likewise be formally made of record by the Examiner.

It is respectfully requested that the foregoing Supplemental Information Disclosure Statement (IDS) be incorporated into the official file of the present patent application. A check in the amount of \$180.00 is enclosed to cover the fee for filing a Supplemental IDS, and the Commissioner of Patents and Trademarks is hereby authorized to charge any additional fees, or to credit any overpayment to Deposit Account No. 03-2468.

Respectfully submitted,
Tomishige TAI ET AL

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Enclosures: PTO-1449 form with 2 documents, Check in the amount of \$180.00
FJD:cmm

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to: MAIL STOP AMENDMENT, Commissioner for Patents, Alexandria, VA, on April 30, 2007.

Kelly Espitia



FORM PTO-1449 (REV. 7-80)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO.:	SERIAL NO.:
LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary)		TAI, T. ET AL - 3 PCT		10/551,067
		APPLICANT: Tomishige TAI ET AL.		
		FILING DATE: September 29, 2005	GROUP: 1775	

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA	6,398,560	06/2002	Mizuno (= JP 3-110408)			
	AB						
	AC						
	AD						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
	AI	WO 00-54324	09/2000	International (Spec, pg. 2) (With English Abstract) (previously-submitted)				
	AJ	JP 3-110408	09/2000	Japan (Spec, pg. 2) (= US 6,398,560) (With English Abstract) (previously-submitted)				
	AK	JP 2000-223835	08/2000	Japan (Spec, pg. 2) (With English Abstract) (previously-submitted)				
	AL	JP 7-336026	12/1995	Japan (ISR) - Enclosed (With English Abstract)				
	AM	JP 2004-39543	02/2004	Japan (ISR) - Enclosed (With English Abstract)				

OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.)

AN	
AO	
EXAMINER	DATE CONSIDERED

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.